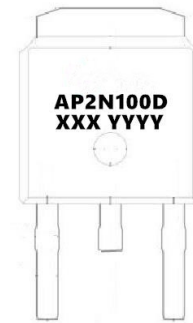
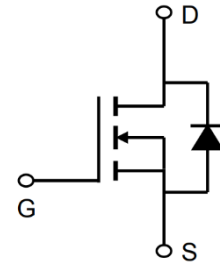


1000V N-Channel Enhancement Mode MOSFET

Description

The AP2N100D is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.



General Features

VDS =650V, ID =2A

RDS(ON) <7.2Ω@ VGS=10V

Application

Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP2N100D	TO-252-3L	AP2N100D XXX YYYY	2500

Absolute Maximum Ratings (T_c=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS = 0V)	1000	V
ID	Continuous Drain Current	2	A
IDM	Pulsed Drain Current	8	A
VGS	Gate-Source Voltage	±30	V
EAS	Single Pulse Avalanche Energy	45	mJ
IAS	Avalanche Current	3	A
EAR	Repetitive Avalanche Energy	27	mJ
PD	Power Dissipation (TC = 25°C)	75	W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55~+150	°C
RthJC	Thermal Resistance, Junction-to-Case	1.67	K/W
RthJA	Thermal Resistance, Junction-to-Ambient	60	K/W



1000V N-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_A=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	1000	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 1000V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA
I _{GSS}	Gate-Source Leakage	V _{GS} = ±20V	--	--	±100	nA
V _{GS(th)}	Gate-Source Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.0	--	4.0	V
R _{DS(on)}	Drain-Source On-Resistance (Note3)	V _{GS} = 10V, I _D = 1.0A	--	6	7.2	Ω
C _{iss}	Input Capacitance	V _{GS} = 0V,	--	419	--	pF
C _{oss}	Output Capacitance	V _{DS} = 25V	--	45	--	
C _{rss}	Reverse Transfer Capacitance	f = 1.0MHz	--	9	--	
Q _g	Total Gate Charge	V _{DD} = 800V,	--	16	--	nC
Q _{gs}	Gate-Source Charge	I _D = 2.0A,	--	2	--	
Q _{gd}	Gate-Drain Charge	V _{GS} = 15V	--	8	--	
t _{d(on)}	Turn-on Delay Time	V _{DD} = 500V I _D = 2.0A, R _G = 25 Ω	--	36	--	ns
t _r	Turn-on Rise Time		--	12	--	
t _{d(off)}	Turn-off Delay Time		--	100	--	
t _f	Turn-off Fall Time		--	43	--	
I _S	Continuous Body Diode Current	T _C = 25 °C	--	--	2	A
I _{SM}	Pulsed Diode Forward Current		--	--	8	
V _{SD}	Body Diode Voltage	T _J = 25°C, I _{SD} = 1.0A, V _{GS} = 0V	--	--	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 2.0A, di _F /dt = 100A/μs	--	432.5	--	ns
Q _{rr}	Reverse Recovery Charge		--	424	--	μC

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L = 10.0mH, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25 °C
3. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%

1000V N-Channel Enhancement Mode MOSFET

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^\circ\text{C}$)

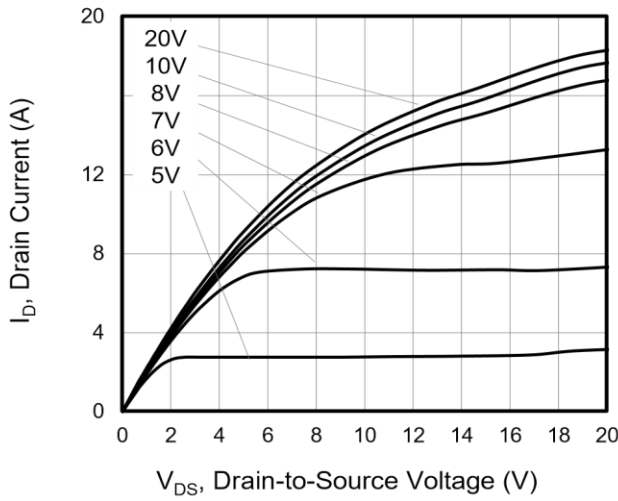


Figure 2. Body Diode Forward Voltage

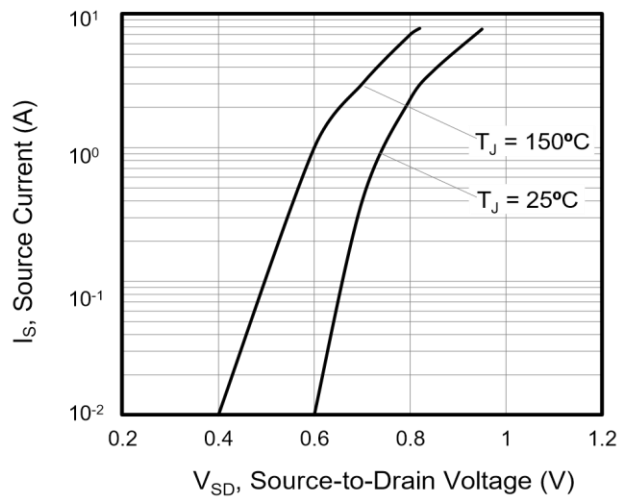


Figure 3. Drain Current vs. Temperature

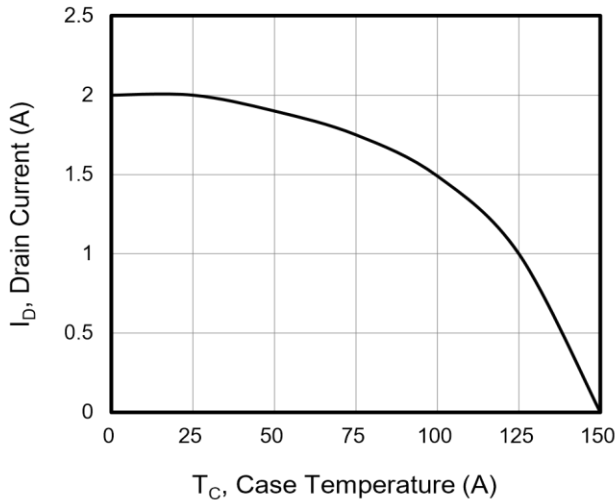


Figure 4. BV_{DSS} Variation vs. Temperature

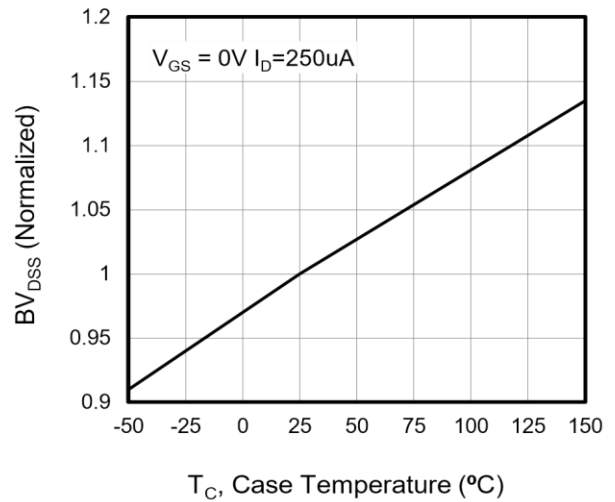


Figure 5. Transfer Characteristics

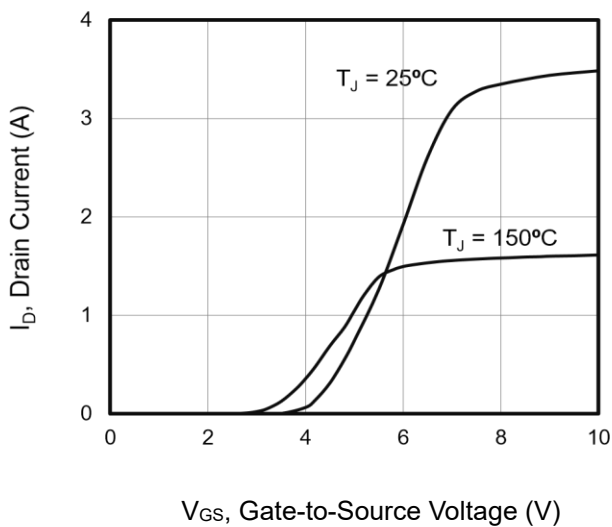
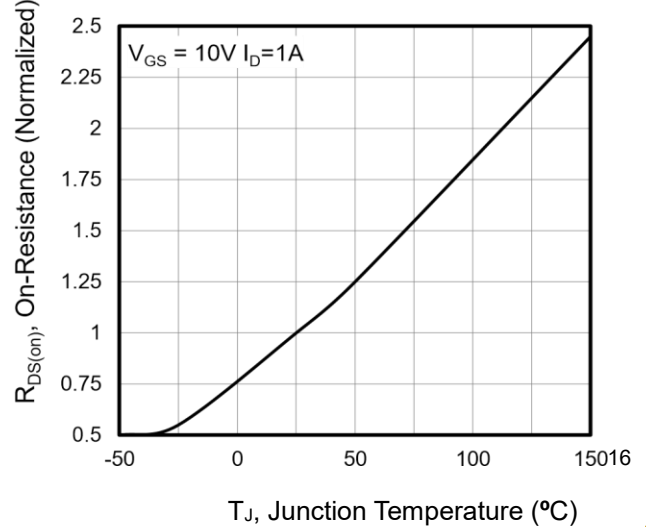


Figure 6. On-Resistance vs. Temperature



1000V N-Channel Enhancement Mode MOSFET

Figure 7. Capacitance

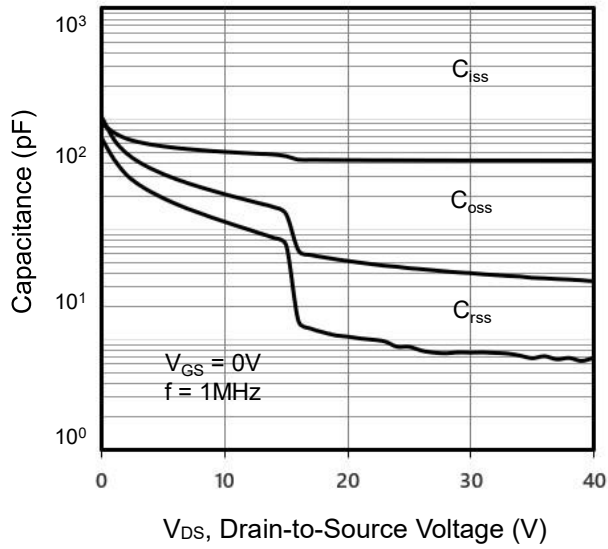


Figure 8. Gate Charge

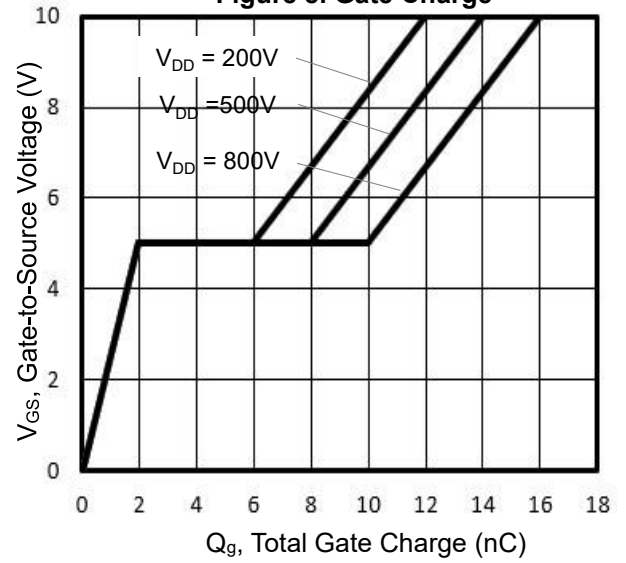


Figure 9. Transient Thermal Impedance

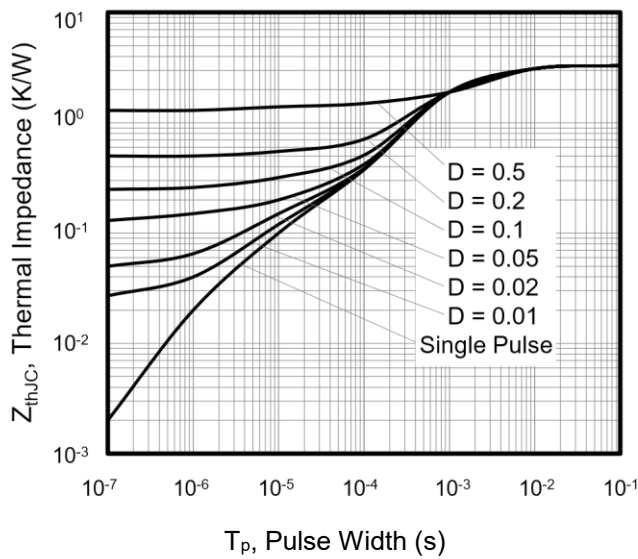
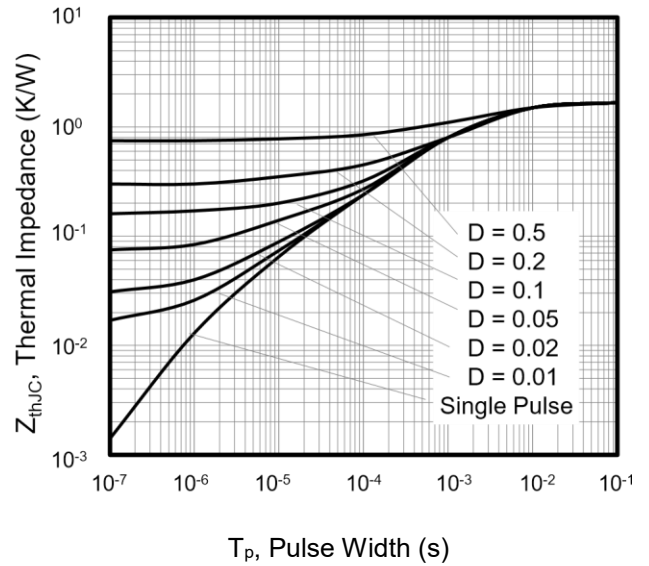
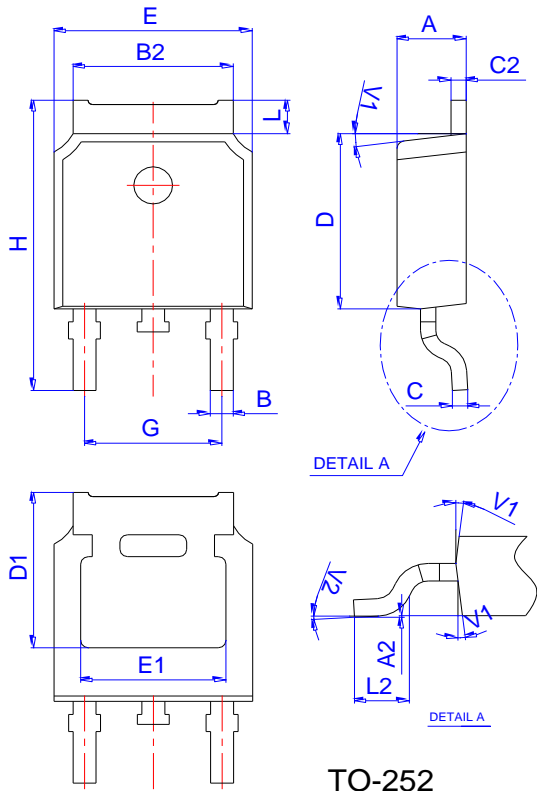


Figure 10. Transient Thermal Impedance



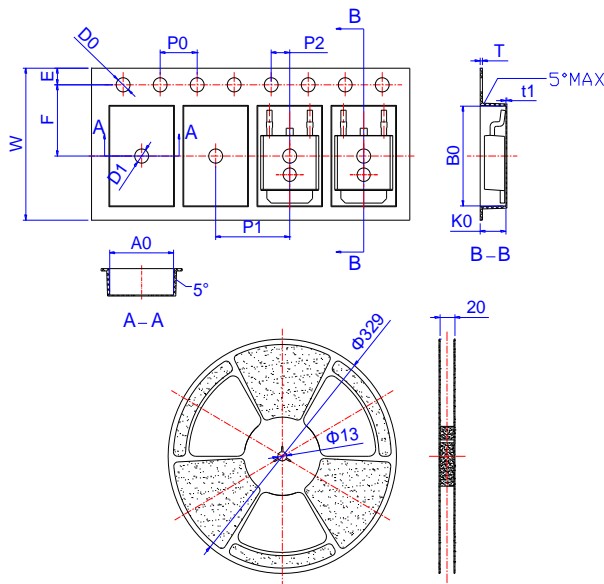
1000V N-Channel Enhancement Mode MOSFET

Package Mechanical Data



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO-252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583